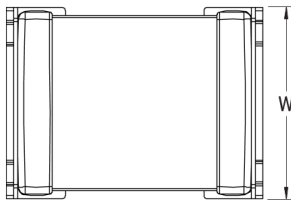


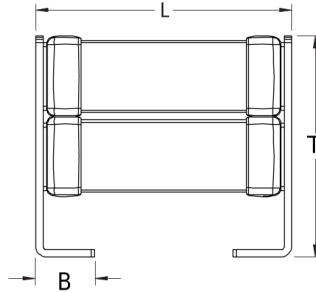
TOP VIEW

Single or Double Chip Stack



SIDE VIEW

Double Chip Stack



Click [here](#) for the 3D model.

Dimensions

L	3.5mm +/-0.3mm
W	2.6mm +/-0.3mm
T	6.15mm +/-0.15mm
B	0.8mm +/-0.15mm

Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	300

General Information

Series	KPS SMD Comm X7R
Style	Stacked Chip
Description	SMD, MLCC, Stacked, Double Chip, Temperature Stable
Features	Temperature Stable
RoHS	Yes
Termination	Tin
AEC-Q200	No
Typical Component Weight	290 mg
Chip Size	1210-2
Shelf Life	78 Weeks
MSL	1

Specifications

Capacitance	22 uF
Measurement Condition	120 Hz 0.5Vrms
Capacitance Tolerance	20%
Voltage DC	25 VDC
Dielectric Withstanding Voltage	62.5 VDC
Temperature Range	-55/+125°C
Temperature Coefficient	X7R
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	15%, 120Hz 0.5Vrms
Dissipation Factor	10% 120 Hz 0.5Vrms
Aging Rate	3% Loss/Decade Hour: Referee Time is 1000 Hours
Insulation Resistance	22.7 MOhms

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